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Understanding Embedded - Microprocessors

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Applications of Embedded - Microprocessors

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details	
Product Status	Obsolete
Core Processor	PowerPC G2_LE
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	333MHz
Co-Processors/DSP	Communications; RISC CPM
RAM Controllers	DRAM, SDRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10/100Mbps (3)
SATA	-
USB	USB 2.0 (1)
Voltage - I/O	3.3V
Operating Temperature	-40°C ~ 105°C (TA)
Security Features	-
Package / Case	480-LBGA Exposed Pad
Supplier Device Package	480-TBGA (37.5x37.5)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/kmpc8270cvvqlda

2 **Caution:** VDD/VCCSYN must not exceed VDDH by more than 0.4 V during normal operation. It is recommended that VDD/VCCSYN should be raised before or simultaneous with VDDH during power-on reset. VDD/VCCSYN may exceed VDDH by more than 0.4 V during power-on reset for no more than 100 ms.

3 **Caution:** VDDH can exceed VDD/VCCSYN by 3.3 V during power on reset by no more than 100 mSec. VDDH should not exceed VDD/VCCSYN by more than 2.5 V during normal operation.

4 **Caution:** VIN must not exceed VDDH by more than 2.5 V at any time, including during power-on reset.

This table lists recommended operational voltage conditions.

Table 4. Recommended Operating Conditions[1]

Rating	Symbol	Value	Unit
Core supply voltage	VDD	1.45 – 1.60	V
PLL supply voltage	VCCSYN	1.45 – 1.60	V
I/O supply voltage	VDDH	3.135 – 3.465	V
Input voltage	VIN	GND (–0.3) – 3.465	V
Junction temperature (maximum)	T_j	105[2]	°C
Ambient temperature	T_A	0–70[2]	°C

1 **Caution:** These are the recommended and tested operating conditions. Proper operation outside of these conditions is not guaranteed.

2 Note that for extended temperature parts the range is $(-40)_{T_A} – 105_{T_j}$.

This SoC contains circuitry protecting against damage due to high static voltage or electrical fields; however, it is advised that normal precautions be taken to avoid application of any voltages higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (either GND or V_{CC}).

This figure shows the undershoot and overshoot voltage of the 60x and local bus memory interface of the SoC. Note that in PCI mode the I/O interface is different.

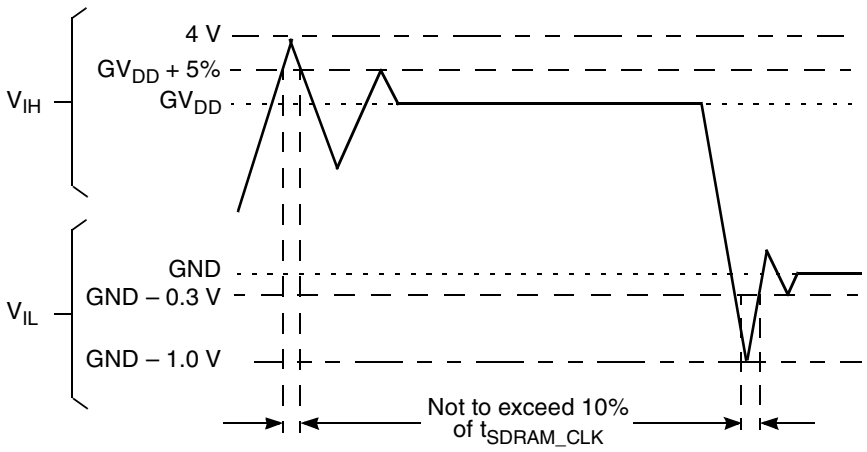

Figure 2. Overshoot/Undershoot Voltage

5 Power Dissipation

This table provides preliminary, estimated power dissipation for various configurations. Note that suitable thermal management is required to ensure the junction temperature does not exceed the maximum specified value. Also note that the I/O power should be included when determining whether to use a heat sink. For a complete list of possible clock configurations, see Section 7, “Clock Configuration Modes.”

Table 7. Estimated Power Dissipation for Various Configurations[1]

Bus (MHz)	CPM Multiplication Factor	CPM (MHz)	CPU Multiplication Factor	CPU (MHz)	P_{INT}(W)[2,3]	
					Vddl 1.5 Volts	
					Nominal	Maximum
66.67	2.5	166	3.5	233	0.95	1.0
66.67	2.5	166	4	266	1.0	1.05
66.67	3	200	4	266	1.05	1.1
66.67	3.5	233	4.5	300	1.05	1.15
83.33	3	250	4	333	1.25	1.35
83.33	3	250	4.5	375	1.3	1.4
83.33	3.5	292	5	417	1.45	1.55
100	3	300	4	400	1.5	1.6
100	3	300	4.5	450	1.55	1.65

1 Test temperature = 105° C

2 $P_{INT} = I_{DD} \times V_{DD}$ Watts

3 Values do not include I/O. Add the following estimates for active I/O based on the following bus speeds:
66.7 MHz = 0.45 W (nominal), 0.5 W (maximum)
83.3 MHz = 0.5W (nominal), 0.6 W (maximum)
100 MHz = 0.6 W (nominal), 0.7 W (maximum)

This table lists CPM input characteristics.

NOTE: Rise/Fall Time on CPM Input Pins

It is recommended that the rise/fall time on CPM input pins should not exceed 5 ns. This should be enforced especially on clock signals. Rise time refers to signal transitions from 10% to 90% of VCC; fall time refers to transitions from 90% to 10% of VCC.

Table 10. AC Characteristics for CPM Inputs[1]

Spec Number		Characteristic	Value (ns)					
Setup	Hold		Setup			Hold		
			66 MHz	83 MHz	100 MHz	66 MHz	83 MHz	100 MHz
sp16a	sp17a	FCC inputs—internal clock (NMSI)	6	6	6	0	0	0
sp16b	sp17b	FCC inputs—external clock (NMSI)	2.5	2.5	2.5	2	2	2
sp18a	sp19a	SCC/SMC/SPI/I2C inputs—internal clock (NMSI)	6	6	6	0	0	0
sp18b	sp19b	SCC/SMC/SPI/I2C inputs—external clock (NMSI)	4	4	4	2	2	2
sp20	sp21	TDM inputs/SI	5	5	5	2.5	2.5	2.5
sp22	sp23	PIO/TIMER/IDMA inputs	8	8	8	0.5	0.5	0.5

1 Input specifications are measured from the 50% level of the signal to the 50% level of the rising edge of CLKIN. Timings are measured at the pin.

NOTE

Although the specifications generally reference the rising edge of the clock, the following AC timing diagrams also apply when the falling edge is the active edge.

This figure shows the FCC internal clock.

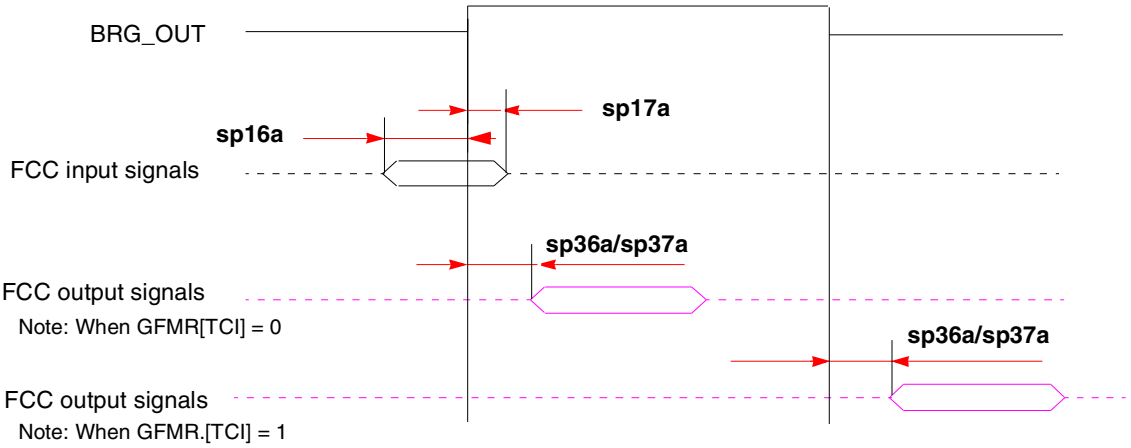

Figure 3. FCC Internal Clock Diagram

NOTE

Activating data pipelining (setting BR*x*[DR] in the memory controller) improves the AC timing.

This table lists SIU input characteristics.

Table 13. AC Characteristics for SIU Inputs[1]

Spec Number		Characteristic	Value (ns)					
Setup	Hold		Setup			Hold		
			66 MHz	83 MHz	100 MHz	66 MHz	83 MHz	100 MHz
sp11	sp10	$\overline{\text{AACK}}$/$\overline{\text{TA}}$/$\overline{\text{TS}}$/$\overline{\text{DBG}}$/$\overline{\text{BG}}$/$\overline{\text{BR}}$/$\overline{\text{ARTRY}}$/ $\overline{\text{TEA}}$	6	5	3.5	0.5	0.5	0.5
sp12	sp10	Data bus in normal mode	5	4	3.5	0.5	0.5	0.5
sp13	sp10	Data bus in ECC and PARITY modes	7	5	3.5	0.5	0.5	0.5
sp13a	sp10	Pipeline mode—Data bus (with or without ECC/PARITY)	5	4	2.5	0.5	0.5	0.5
sp14	sp10	DP pins	7	5	3.5	0.5	0.5	0.5
sp14a	sp10	Pipeline mode—DP pins	—	4	2.5	—	0.5	0.5
sp15	sp10	All other pins	5	4	3.5	0.5	0.5	0.5

1 Input specifications are measured from the 50% level of the signal to the 50% level of the rising edge of CLKIN. Timings are measured at the pin.

This table lists SIU output characteristics.

Table 14. AC Characteristics for SIU Outputs[1]

Spec Number		Characteristic	Value (ns)					
Max	Min		Maximum Delay			Minimum Delay		
			66 MHz	83 MHz	100 MHz	66 MHz	83 MHz	100 MHz
sp31	sp30	$\overline{\text{PSDVAL}}$/$\overline{\text{TEA}}$/$\overline{\text{TA}}$	7	6	5.5	1	1	1
sp32	sp30	ADD/ADD_atr./BADDR/CI/GBL/WT	8	6.5	5.5	1	1	1
sp33a	sp30	Data bus[2]	6.5	6.5	5.5	0.7	0.7	0.7
sp33b	sp30	DP	6	5.5	5.5	1	1	1
sp34	sp30	Memory controller signals/ALE	6	5.5	5.5	1	1	1
sp35	sp30	All other signals	6	5.5	5.5	1	1	1
sp35a	sp30	AP	7	7	7	1	1	1

1 Output specifications are measured from the 50% level of the rising edge of CLKIN to the 50% level of the signal. Timings are measured at the pin.

2 To achieve 1 ns of hold time at 66, 83, or 100 MHz, a minimum loading of 20 pF is required.

This figure shows signal behavior for all parity modes (including ECC, RMW parity, and standard parity).

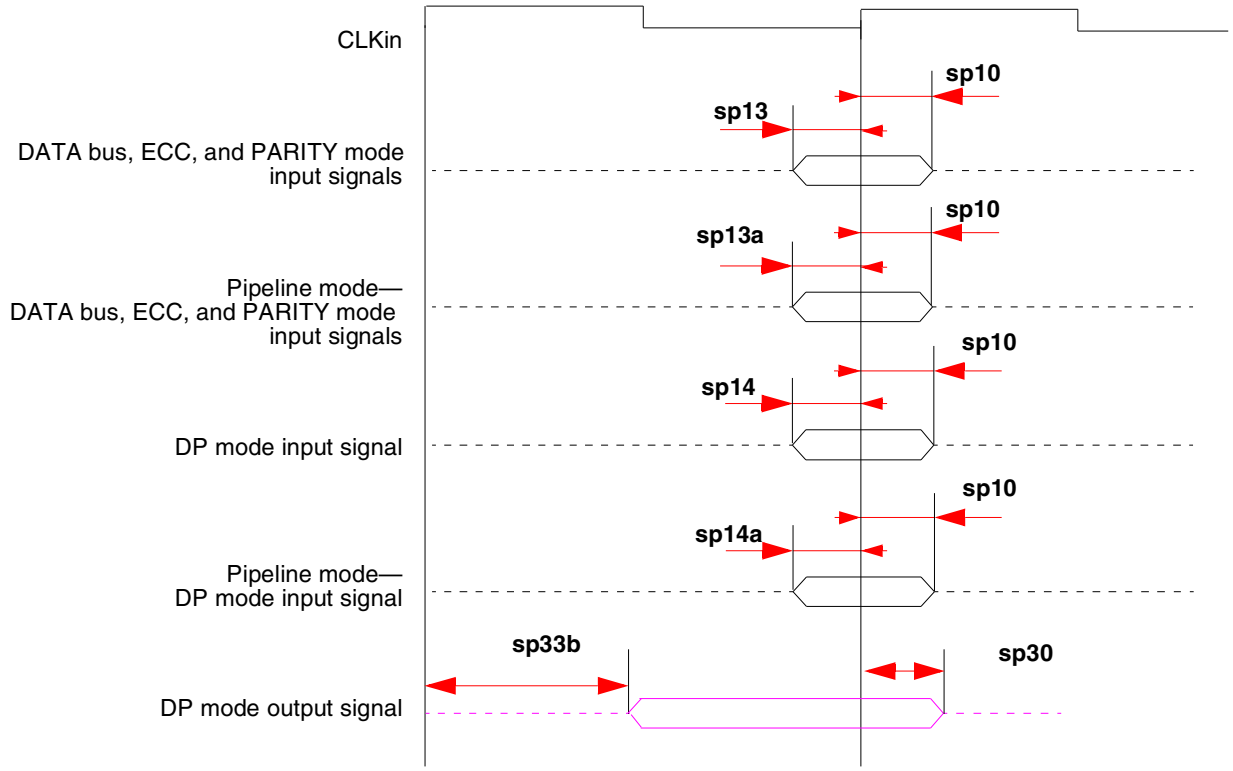

Figure 10. Parity Mode Diagram

This figure shows signal behavior in MEMC mode.

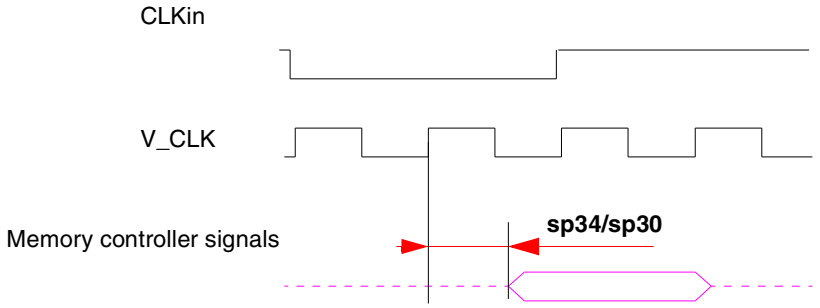

Figure 11. MEMC Mode Diagram

NOTE

Generally, all SoC bus and system output signals are driven from the rising edge of the input clock (CLKin). Memory controller signals, however, trigger on four points within a CLKin cycle. Each cycle is divided by four internal ticks: T1, T2, T3, and T4. T1 always occurs at the rising edge, and T3 at the falling edge, of CLKin. However, the spacing of T2 and T4 depends on the PLL clock ratio selected, as shown in Table 15.

Table 16. JTAG Timings[1] (continued)

Parameter	Symbol[2]	Min	Max	Unit	Notes
Input hold times Boundary-scan data TMS, TDI	 t_{JTDXKH} t_{JTIXKH}	 10 10	 — —	 ns ns	 4, 7 4, 7
Output valid times Boundary-scan data TDO	 t_{JTKLDV} t_{JTKLOV}	 — —	 10 10	 ns ns	 5, 7 5, 7
Output hold times Boundary-scan data TDO	 t_{JTKLDX} t_{JTKLOX}	 1 1	 — —	 ns ns	 5, 7 5, 7
JTAG external clock to output high impedance Boundary-scan data TDO	 t_{JTKLDZ} t_{JTKLOZ}	 1 1	 10 10	 ns ns	 5, 6 5, 6

1 All outputs are measured from the midpoint voltage of the falling/rising edge of t_{TCLK} to the midpoint of the signal in question. The output timings are measured at the pins. All output timings assume a purely resistive 50-Ω load. Time-of-flight delays must be added for trace lengths, vias, and connectors in the system.

2 The symbols used for timing specifications herein follow the pattern of $t_{\text{(first two letters of functional block)(signal)(state) (reference)(state)}}$ for inputs and $t_{\text{(first two letters of functional block)(reference)(state)(signal)(state)}}$ for outputs. For example, t_{JTDVKH} symbolizes JTAG device timing (JT) with respect to the time data input signals (D) reaching the valid state (V) relative to the t_{JTG} clock reference (K) going to the high (H) state or setup time. Also, t_{JTDXKH} symbolizes JTAG timing (JT) with respect to the time data input signals (D) went invalid (X) relative to the t_{JTG} clock reference (K) going to the high (H) state. Note that, in general, the clock reference symbol representation is based on three letters representing the clock of a particular functional. For rise and fall times, the latter convention is used with the appropriate letter: R (rise) or F (fall).

3 TRST is an asynchronous level sensitive signal. The setup time is for test purposes only.

4 Non-JTAG signal input timing with respect to t_{TCLK}.

5 Non-JTAG signal output timing with respect to t_{TCLK}.

6 Guaranteed by design.

7 Guaranteed by design and device characterization.

7 Clock Configuration Modes

This SoC includes the following clocking modes:

- Local
- PCI host
- PCI agent

The clocking mode is set according to the following input pins as shown in the following table:

- PCI_MODE
- PCI_CFG[0]
- PCI_MODCK

Table 19. Clock Configurations for PCI Host Mode (PCI_MODCK=0)[1,2] (continued)

Mode[3]	Bus Clock[4] (MHz)		CPM Multiplication Factor[5]	CPM Clock (MHz)		CPU Multiplication Factor[6]	CPU Clock (MHz)		PCI Division Factor	PCI Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
0001_001	50.0	66.7	3	150.0	200.0	6	300.0	400.0	3	50.0	66.7
0001_010	50.0	66.7	3	150.0	200.0	7	350.0	466.6	3	50.0	66.7
0001_011	50.0	66.7	3	150.0	200.0	8	400.0	533.3	3	50.0	66.7
0010_000	50.0	66.7	4	200.0	266.6	5	250.0	333.3	4	50.0	66.7
0010_001	50.0	66.7	4	200.0	266.6	6	300.0	400.0	4	50.0	66.7
0010_010	50.0	66.7	4	200.0	266.6	7	350.0	466.6	4	50.0	66.7
0010_011	50.0	66.7	4	200.0	266.6	8	400.0	533.3	4	50.0	66.7
0010_100	75.0	100.0	4	300.0	400.0	5	375.0	500.0	6	50.0	66.7
0010_101	75.0	100.0	4	300.0	400.0	5.5	412.5	549.9	6	50.0	66.7
0010_110	75.0	100.0	4	300.0	400.0	6	450.0	599.9	6	50.0	66.7
0011_000	50.0	66.7	5	250.0	333.3	5	250.0	333.3	5	50.0	66.7
0011_001	50.0	66.7	5	250.0	333.3	6	300.0	400.0	5	50.0	66.7
0011_010	50.0	66.7	5	250.0	333.3	7	350.0	466.6	5	50.0	66.7
0011_011	50.0	66.7	5	250.0	333.3	8	400.0	533.3	5	50.0	66.7
0100_000	Reserved										
0100_001	50.0	66.7	6	300.0	400.0	6	300.0	400.0	6	50.0	66.7
0100_010	50.0	66.7	6	300.0	400.0	7	350.0	466.6	6	50.0	66.7
0100_011	50.0	66.7	6	300.0	400.0	8	400.0	533.3	6	50.0	66.7
0101_000	60.0	66.7	2	120.0	133.3	2.5	150.0	166.7	2	60.0	66.7
0101_001	50.0	66.7	2	100.0	133.3	3	150.0	200.0	2	50.0	66.7
0101_010	50.0	66.7	2	100.0	133.3	3.5	175.0	233.3	2	50.0	66.7
0101_011	50.0	66.7	2	100.0	133.3	4	200.0	266.6	2	50.0	66.7
0101_100	50.0	66.7	2	100.0	133.3	4.5	225.0	300.0	2	50.0	66.7
0110_000	60.0	80.0	2.5	150.0	200.0	2.5	150.0	200.0	3	50.0	66.7
0110_001	60.0	80.0	2.5	150.0	200.0	3	180.0	240.0	3	50.0	66.7
0110_010	60.0	80.0	2.5	150.0	200.0	3.5	210.0	280.0	3	50.0	66.7

Table 20. Clock Configurations for PCI Host Mode (PCI_MODCK=1)[1,2] (continued)

Mode[3]	Bus Clock[4] (MHz)		CPM Multiplication Factor[5]	CPM Clock (MHz)		CPU Multiplication Factor[6]	CPU Clock (MHz)		PCI Division Factor	PCI Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
0010_110	37.5	75.0	4	150.0	300.0	6	225.0	450.0	6	25.0	50.0
0011_000	30.0	50.0	5	150.0	250.0	5	150.0	250.0	5	30.0	50.0
0011_001	25.0	50.0	5	125.0	250.0	6	150.0	300.0	5	25.0	50.0
0011_010	25.0	50.0	5	125.0	250.0	7	175.0	350.0	5	25.0	50.0
0011_011	25.0	50.0	5	125.0	250.0	8	200.0	400.0	5	25.0	50.0
0100_000	Reserved										
0100_001	25.0	50.0	6	150.0	300.0	6	150.0	300.0	6	25.0	50.0
0100_010	25.0	50.0	6	150.0	300.0	7	175.0	350.0	6	25.0	50.0
0100_011	25.0	50.0	6	150.0	300.0	8	200.0	400.0	6	25.0	50.0
0101_000	60.0	100.0	2	120.0	200.0	2.5	150.0	250.0	4	30.0	50.0
0101_001	50.0	100.0	2	100.0	200.0	3	150.0	300.0	4	25.0	50.0
0101_010	50.0	100.0	2	100.0	200.0	3.5	175.0	350.0	4	25.0	50.0
0101_011	50.0	100.0	2	100.0	200.0	4	200.0	400.0	4	25.0	50.0
0101_100	50.0	100.0	2	100.0	200.0	4.5	225.0	450.0	4	25.0	50.0
0110_000	60.0	120.0	2.5	150.0	300.0	2.5	150.0	300.0	6	25.0	50.0
0110_001	60.0	120.0	2.5	150.0	300.0	3	180.0	360.0	6	25.0	50.0
0110_010	60.0	120.0	2.5	150.0	300.0	3.5	210.0	420.0	6	25.0	50.0
0110_011	60.0	120.0	2.5	150.0	300.0	4	240.0	480.0	6	25.0	50.0
0110_100	60.0	120.0	2.5	150.0	300.0	4.5	270.0	540.0	6	25.0	50.0
0110_101	60.0	120.0	2.5	150.0	300.0	5	300.0	600.0	6	25.0	50.0
0110_110	60.0	120.0	2.5	150.0	300.0	6	360.0	720.0	6	25.0	50.0
0111_000	Reserved										
0111_001	50.0	100.0	3	150.0	300.0	3	150.0	300.0	6	25.0	50.0
0111_010	50.0	100.0	3	150.0	300.0	3.5	175.0	350.0	6	25.0	50.0
0111_011	50.0	100.0	3	150.0	300.0	4	200.0	400.0	6	25.0	50.0
0111_100	50.0	100.0	3	150.0	300.0	4.5	225.0	450.0	6	25.0	50.0

Table 20. Clock Configurations for PCI Host Mode (PCI_MODCK=1)[1,2] (continued)

Mode[3]	Bus Clock[4] (MHz)		CPM Multiplication Factor[5]	CPM Clock (MHz)		CPU Multiplication Factor[6]	CPU Clock (MHz)		PCI Division Factor	PCI Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
1000_000	Reserved										
1000_001	66.7	133.3	3	200.0	400.0	3	200.0	400.0	8	25.0	50.0
1000_010	66.7	133.3	3	200.0	400.0	3.5	233.3	466.7	8	25.0	50.0
1000_011	66.7	133.3	3	200.0	400.0	4	266.7	533.3	8	25.0	50.0
1000_100	66.7	133.3	3	200.0	400.0	4.5	300.0	600.0	8	25.0	50.0
1000_101	66.7	133.3	3	200.0	400.0	6	400.0	800.0	8	25.0	50.0
1000_110	66.7	133.3	3	200.0	400.0	6.5	433.3	866.7	8	25.0	50.0
1001_000	Reserved										
1001_001	Reserved										
1001_010	57.1	114.3	3.5	200.0	400.0	3.5	200.0	400.0	8	25.0	50.0
1001_011	57.1	114.3	3.5	200.0	400.0	4	228.6	457.1	8	25.0	50.0
1001_100	57.1	114.3	3.5	200.0	400.0	4.5	257.1	514.3	8	25.0	50.0
1001_101	42.9	85.7	3.5	150.0	300.0	5	214.3	428.6	6	25.0	50.0
1001_110	42.9	85.7	3.5	150.0	300.0	5.5	235.7	471.4	6	25.0	50.0
1001_111	42.9	85.7	3.5	150.0	300.0	6	257.1	514.3	6	25.0	50.0
1010_000	75.0	150.0	2	150.0	300.0	2	150.0	300.0	6	25.0	50.0
1010_001	75.0	150.0	2	150.0	300.0	2.5	187.5	375.0	6	25.0	50.0
1010_010	75.0	150.0	2	150.0	300.0	3	225.0	450.0	6	25.0	50.0
1010_011	75.0	150.0	2	150.0	300.0	3.5	262.5	525.0	6	25.0	50.0
1010_100	75.0	150.0	2	150.0	300.0	4	300.0	600.0	6	25.0	50.0
1011_000	Reserved										
1011_001	80.0	160.0	2.5	200.0	400.0	2.5	200.0	400.0	8	25.0	50.0
1011_010	80.0	160.0	2.5	200.0	400.0	3	240.0	480.0	8	25.0	50.0
1011_011	80.0	160.0	2.5	200.0	400.0	3.5	280.0	560.0	8	25.0	50.0
1011_100	80.0	160.0	2.5	200.0	400.0	4	320.0	640.0	8	25.0	50.0
1011_101	80.0	160.0	2.5	200.0	400.0	4.5	360.0	720.0	8	25.0	50.0
1101_000	50.0	100.0	2.5	125.0	250.0	3	150.0	300.0	5	25.0	50.0

NOTE: PCI_MODCK

In PCI mode only, PCI_MODCK comes from the LGPL5 pin and MODCK_H[0–3] comes from {LGPL0, LGPL1, LGPL2, LGPL3}.

NOTE: Tval (Output Hold)

The minimum Tval = 2 ns when PCI_MODCK = 1, and the minimum Tval = 1 ns when PCI_MODCK = 0. Therefore, designers should use clock configurations that fit this condition to achieve PCI-compliant AC timing.

Table 21. Clock Configurations for PCI Agent Mode (PCI_MODCK=0)[1,2]

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
Default Modes (MODCK_H=0000											
0000_000	60.0	66.7	2	120.0	133.3	2.5	150.0	166.7	2	60.0	66.7
0000_001	50.0	66.7	2	100.0	133.3	3	150.0	200.0	2	50.0	66.7
0000_010	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0000_011	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
0000_100	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0
0000_101	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0
0000_110	50.0	66.7	4	200.0	266.6	3.5	233.3	311.1	3	66.7	88.9
0000_111	50.0	66.7	4	200.0	266.6	3	240.0	320.0	2.5	80.0	106.7
Full Configuration Modes											
0001_001	60.0	66.7	2	120.0	133.3	5	150.0	166.7	4	30.0	33.3
0001_010	50.0	66.7	2	100.0	133.3	6	150.0	200.0	4	25.0	33.3
0001_011	50.0	66.7	2	100.0	133.3	7	175.0	233.3	4	25.0	33.3
0001_100	50.0	66.7	2	100.0	133.3	8	200.0	266.6	4	25.0	33.3
0010_001	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0
0010_010	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0
0010_011	50.0	66.7	3	150.0	200.0	4	240.0	320.0	2.5	60.0	80.0
0010_100	50.0	66.7	3	150.0	200.0	4.5	270.0	360.0	2.5	60.0	80.0
0011_000	Reserved										
0011_001	Reserved										
0011_010	Reserved										
0011_011	Reserved										
0011_100	Reserved										

Table 21. Clock Configurations for PCI Agent Mode (PCI_MODCK=0)[1,2] (continued)

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
0100_000	Reserved										
0100_001	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0100_010	50.0	66.7	3	150.0	200.0	3.5	175.0	200.0	3	50.0	66.7
0100_011	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
0100_100	50.0	66.7	3	150.0	200.0	4.5	225.0	300.0	3	50.0	66.7
0101_000	50.0	66.7	5	250.0	333.3	2.5	250.0	333.3	2.5	100.0	133.3
0101_001	50.0	66.7	5	250.0	333.3	3	300.0	400.0	2.5	100.0	133.3
0101_010	50.0	66.7	5	250.0	333.3	3.5	350.0	466.6	2.5	100.0	133.3
0101_011	50.0	66.7	5	250.0	333.3	4	400.0	533.3	2.5	100.0	133.3
0101_100	50.0	66.7	5	250.0	333.3	4.5	450.0	599.9	2.5	100.0	133.3
0101_101	50.0	66.7	5	250.0	333.3	5	500.0	666.6	2.5	100.0	133.3
0101_110	50.0	66.7	5	250.0	333.3	5.5	550.0	733.3	2.5	100.0	133.3
0110_000	Reserved										
0110_001	50.0	66.7	4	200.0	266.6	3	200.0	266.6	3	66.7	88.9
0110_010	50.0	66.7	4	200.0	266.6	3.5	233.3	311.1	3	66.7	88.9
0110_011	50.0	66.7	4	200.0	266.6	4	266.7	355.5	3	66.7	88.9
0110_100	50.0	66.7	4	200.0	266.6	4.5	300.0	400.0	3	66.7	88.9
0111_000	50.0	66.7	3	150.0	200.0	2	150.0	200.0	2	75.0	100.0
0111_001	50.0	66.7	3	150.0	200.0	2.5	187.5	250.0	2	75.0	100.0
0111_010	50.0	66.7	3	150.0	200.0	3	225.0	300.0	2	75.0	100.0
0111_011	50.0	66.7	3	150.0	200.0	3.5	262.5	350.0	2	75.0	100.0
1000_000	Reserved										
1000_001	50.0	66.7	3	150.0	200.0	2.5	150.0	166.7	2.5	60.0	80.0
1000_010	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0
1000_011	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0
1000_100	50.0	66.7	3	150.0	200.0	4	240.0	320.0	2.5	60.0	80.0
1000_101	50.0	66.7	3	150.0	200.0	4.5	270.0	360.0	2.5	60.0	80.0

Table 21. Clock Configurations for PCI Agent Mode (PCI_MODCK=0)[1,2] (continued)

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
1110_011	50.0	66.7	5	250.0	333.3	4	500.0	666.6	2	125.0	166.7
1110_100	50.0	66.7	5	250.0	333.3	4	333.3	444.4	3	83.3	111.1
1110_101	50.0	66.7	5	250.0	333.3	4.5	375.0	500.0	3	83.3	111.1
1110_110	50.0	66.7	5	250.0	333.3	5	416.7	555.5	3	83.3	111.1
1110_111	50.0	66.7	5	250.0	333.3	5.5	458.3	611.1	3	83.3	111.1
1100_000	Reserved										
1100_001	Reserved										
1100_010	Reserved										

1 The “low” values are the minimum allowable frequencies for a given clock mode. The minimum bus frequency in a table entry guarantees only the required minimum CPU operating frequency. The “high” values are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not violate the frequency rating of the user’s device. The minimum CPM frequency is 120 MHz. Minimum CPU frequency is determined by the clock mode. For modes with a CPU multiplication factor <= 3, the minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices. For modes with a CPU multiplication factor >= 3.5: for Rev 0.1 the minimum CPU frequency is 250 MHz; for Rev A or later the minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices.

2 As shown in Table 17, PCI_MODCK determines the PCI clock frequency range. See Table 20 for lower configurations.

3 MODCK_H = hard reset configuration word [28–31]. MODCK[1-3] = three hardware configuration pins.

4 CPM multiplication factor = CPM clock/PCI clock

5 CPU multiplication factor = Core PLL multiplication factor

Table 22. Clock Configurations for PCI Agent Mode (PCI_MODCK=1)[1,2]

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
Default Modes (MODCK_H=0000)											
0000_000	30.0	50.0	4	120.0	200.0	2.5	150.0	250.0	2	60.0	100.0
0000_001	25.0	50.0	4	100.0	200.0	3	150.0	300.0	2	50.0	100.0
0000_010	25.0	50.0	6	150.0	300.0	3	150.0	300.0	3	50.0	100.0
0000_011	25.0	50.0	6	150.0	300.0	4	200.0	400.0	3	50.0	100.0
0000_100	25.0	50.0	6	150.0	300.0	3	180.0	360.0	2.5	60.0	120.0
0000_101	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
0000_110	25.0	50.0	8	200.0	400.0	3.5	233.3	466.7	3	66.7	133.3

Table 22. Clock Configurations for PCI Agent Mode (PCI_MODCK=1)[1,2] (continued)

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
0000_111	25.0	50.0	8	200.0	400.0	3	240.0	480.0	2.5	80.0	160.0
Full Configuration Modes											
0001_001	30.0	50.0	4	120.0	200.0	5	150.0	250.0	4	30.0	50.0
0001_010	25.0	50.0	4	100.0	200.0	6	150.0	300.0	4	25.0	50.0
0001_011	25.0	50.0	4	100.0	200.0	7	175.0	350.0	4	25.0	50.0
0001_100	25.0	50.0	4	100.0	200.0	8	200.0	400.0	4	25.0	50.0
0010_001	25.0	50.0	6	150.0	300.0	3	180.0	360.0	2.5	60.0	120.0
0010_010	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
0010_011	25.0	50.0	6	150.0	300.0	4	240.0	480.0	2.5	60.0	120.0
0010_100	25.0	50.0	6	150.0	300.0	4.5	270.0	540.0	2.5	60.0	120.0
0011_000	Reserved										
0011_001	37.5	50.0	4	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0011_010	32.1	50.0	4	128.6	200.0	3.5	150.0	233.3	3	42.9	66.7
0011_011	28.1	50.0	4	112.5	200.0	4	150.0	266.7	3	37.5	66.7
0011_100	25.0	50.0	4	100.0	200.0	4.5	150.0	300.0	3	33.3	66.7
0100_000	Reserved										
0100_001	25.0	50.0	6	150.0	300.0	3	150.0	300.0	3	50.0	100.0
0100_010	25.0	50.0	6	150.0	300.0	3.5	175.0	350.0	3	50.0	100.0
0100_011	25.0	50.0	6	150.0	300.0	4	200.0	400.0	3	50.0	100.0
0100_100	25.0	50.0	6	150.0	300.0	4.5	225.0	450.0	3	50.0	100.0
0101_000	30.0	50.0	5	150.0	250.0	2.5	150.0	250.0	2.5	60.0	100.0
0101_001	25.0	50.0	5	125.0	250.0	3	150.0	300.0	2.5	50.0	100.0
0101_010	25.0	50.0	5	125.0	250.0	3.5	175.0	350.0	2.5	50.0	100.0
0101_011	25.0	50.0	5	125.0	250.0	4	200.0	400.0	2.5	50.0	100.0
0101_100	25.0	50.0	5	125.0	250.0	4.5	225.0	450.0	2.5	50.0	100.0
0101_101	25.0	50.0	5	125.0	250.0	5	250.0	500.0	2.5	50.0	100.0
0101_110	25.0	50.0	5	125.0	250.0	5.5	275.0	550.0	2.5	50.0	100.0

Table 23. MPC8280 and MPC8270 (ZU and VV Packages) Pinout List (continued)

Pin Name		Ball
MPC8280/MPC8270	MPC8280 only	
$\overline{ABB}$/$\overline{IRQ2}$		E2
$\overline{TS}$		E3
A0		G1
A1		H5
A2		H2
A3		H1
A4		J5
A5		J4
A6		J3
A7		J2
A8		J1
A9		K4
A10		K3
A11		K2
A12		K1
A13		L5
A14		L4
A15		L3
A16		L2
A17		L1
A18		M5
A19		N5
A20		N4
A21		N3
A22		N2
A23		N1
A24		P4
A25		P3
A26		P2
A27		P1
A28		R1
A29		R3
A30		R5

Table 23. MPC8280 and MPC8270 (ZU and VV Packages) Pinout List (continued)

Pin Name		Ball
MPC8280/MPC8270	MPC8280 only	
D51		C12
D52		B10
D53		A7
D54		C6
D55		D5
D56		B18
D57		B16
D58		E14
D59		D12
D60		C10
D61		E8
D62		D6
D63		C2
DP0/$\overline{\text{RSRV}}$/$\overline{\text{EXT\_BR2}}$		B22
$\overline{\text{IRQ1}}$/DP1/$\overline{\text{EXT\_BG2}}$		A22
$\overline{\text{IRQ2}}$/DP2/$\overline{\text{TLBISYNC}}$/$\overline{\text{EXT\_DBG2}}$		E21
$\overline{\text{IRQ3}}$/DP3/$\overline{\text{CKSTP\_OUT}}$/$\overline{\text{EXT\_BR3}}$		D21
$\overline{\text{IRQ4}}$/DP4/$\overline{\text{CORE\_SRESET}}$/$\overline{\text{EXT\_BG3}}$		C21
$\overline{\text{IRQ5}}$/$\overline{\text{CINT}}$/DP5/$\overline{\text{TBEN}}$/$\overline{\text{EXT\_DBG3}}$		B21
$\overline{\text{IRQ6}}$/DP6/CSE0		A21
$\overline{\text{IRQ7}}$/DP7/CSE1		E20
$\overline{\text{PSDVAL}}$		V3
$\overline{\text{TA}}$		C22
$\overline{\text{TEA}}$		V5
$\overline{\text{GBL}}$/$\overline{\text{IRQ1}}$		W1
$\overline{\text{CI}}$/BADDR29/$\overline{\text{IRQ2}}$		U2
$\overline{\text{WT}}$/BADDR30/$\overline{\text{IRQ3}}$		U3
$\overline{\text{L2\_HIT}}$/$\overline{\text{IRQ4}}$		Y4
$\overline{\text{CPU\_BG}}$/BADDR31/$\overline{\text{IRQ5}}$/$\overline{\text{CINT}}$		U4
$\overline{\text{CPU\_DBG}}$		R2
$\overline{\text{CPU\_BR}}$		Y3
$\overline{\text{CS0}}$		F25
$\overline{\text{CS1}}$		C29

Table 23. MPC8280 and MPC8270 (ZU and VV Packages) Pinout List (continued)

Pin Name		Ball
MPC8280/MPC8270	MPC8280 only	
LSDWE/LGPL1/PCI_MODCKH1		C28
LOE/LSDRAS/LGPL2/PCI_MODCKH2		E26
LSDCAS/LGPL3/PCI_MODCKH3		D25
LGTA/LUPMWAIT/LGPL4/LPBS		C26
LGPL5/LSDAMUX/PCI_MODCK		B27
LWR		D28
L_A14/PAR		N27
L_A15/FRAME/SMI		T29
L_A16/TRDY		R27
L_A17/IRDY/CKSTP_OUT		R26
L_A18/STOP		R29
L_A19/DEVSEL		R28
L_A20/IDSEL		W29
L_A21/PERR		P28
L_A22/SERR		N26
L_A23/REQ0		AA27
L_A24/REQ1/HSEJSW		P29
L_A25/GNT0		AA26
L_A26/GNT1/HSLED		N25
L_A27/GNT2/HSENUM		AA25
L_A28/RST/CORE_SRESET		AB29
L_A29/INTA		AB28
L_A30/REQ2		P25
L_A31/DLLOUT		AB27
LCL_D0/AD0		H29
LCL_D1/AD1		J29
LCL_D2/AD2		J28
LCL_D3/AD3		J27
LCL_D4/AD4		J26
LCL_D5/AD5		J25
LCL_D6/AD6		K25
LCL_D7/AD7		L29
LCL_D8/AD8		L27

Table 23. MPC8280 and MPC8270 (ZU and VV Packages) Pinout List (continued)

Pin Name		Ball
MPC8280/MPC8270	MPC8280 only	
PB10/FCC3_MII_HDLC_RXD2	FCC2_UT8_TXD1/L1RXDD1	AH24[2]
PB11/FCC3_MII_HDLC_RXD3	FCC2_UT8_TXD0/L1TXDD1	AJ24[2]
PB12/FCC3_MII_CRS/TXD2	L1CLKOB1/L1RSYNCC1	AG22[2]
PB13/FCC3_MII_COL/L1TXD1A2	$\overline{\text{L1RQB1}}$/L1TSYNCC1/L1GNTC1	AH21[2]
PB14/FCC3_MII_RMII_TX_EN//RXD3	L1RXDC1	AG20[2]
PB15/FCC3_MII_TX_ER/RXD2	L1TXDC1	AF19[2]
PB16/FCC3_MII_RMII_RX_ER/CLK18	L1CLKOA1	AJ18[2]
PB17/FCC3_MII_RX_DV/CLK17/ FCC3_RMII_CRS_DV	L1RQA1	AJ17[2]
PB18/FCC2_MII_HDLC_RXD3/ L1CLKOD2/L1RXD2A2	FCC2_UT8_RXD4	AE14[2]
PB19FCC2_MII_HDLC_RXD2/ L1RQD2/L1RXD3A2	FCC2_UT8_RXD5	AF13[2]
PB20/FCC2_MII_HDLC_RMII_RXD1/ L1RSYNCD2	FCC2_UT8_RXD6/L1TXD1A1	AG12[2]
PB21//FCC2_MII_HDLC_RMII_RXD0/ FCC2_TRAN_RXD/L1TSYNCD2/ L1GNTD2	FCC2_UT8_RXD7/L1TXD2A1	AH11[2]
PB22/FCC2_MII_HDLC_TXD0/ FCC2_TXD/FCC2_RMII_TXD0/ L1RXDD2	FCC2_UT8_TXD7/L1RXD1A1	AH16[2]
PB23/FCC2_MII_HDLC_TXD1/ L1RXD2A1/L1TXDD2/ FCC2_RMII_TXD1	FCC2_UT8_TXD6/L1RXD2A1	AE15[2]
PB24/FCC2_MII_HDLC_TXD2/ L1RSYNCC2	FCC2_UT8_TXD5/L1RXD3A1	AJ9[2]
PB25/FCC2_MII_HDLC_TXD3/ L1TSYNCC2/L1GNTC2	FCC2_UT8_TXD4/L1TXD3A1	AE9[2]
PB26/FCC2_MII_CRS/L1RXDC2	FCC2_UT8_TXD1	AJ7[2]
PB27/FCC2_MII_COL/L1TXDC2	FCC2_UT8_TXD0	AH6[2]
PB28/FCC2_MII_RX_ER/ FCC2_RMII_RX_ER/$\overline{\text{FCC2\_RTS}}$/ L1TSYNCB2/L1GNTB2/TXD1		AE3[2]
PB29/L1RSYNCB2/FCC2_MII_TX_EN/ FCC2_RMII_TX_EN	FCC2_UTM_RXCLAV/ FCC2_UTS_RXCLAV	AE2[2]
PB30/FCC2_MII_RX_DV/ FCC2_RMII_CRS_DV/L1RXDB2	FCC2_UT_TXSOC	AC5[2]
PB31/FCC2_MII_TX_ER/L1TXDB2	FCC2_UT_RXSOC	AC4[2]

Table 25. MPC8275 and MPC8270 (VR and ZQ Packages) Pinout List (continued)

Pin Name		Ball
MPC8275/MPC8270	MPC8275 only	
LCL_D11/AD11		AC13
LCL_D12/AD12		AC12
LCL_D13/AD13		AB13
LCL_D14/AD14		AD12
LCL_D15/AD15		AF14
LCL_D16/AD16		AF17
LCL_D17/AD17		AE16
LCL_D18/AD18		AD16
LCL_D19/AD19		AC16
LCL_D20/AD20		AB16
LCL_D21/AD21		AF18
LCL_D22/AD22		AE17
LCL_D23/AD23		AD17
LCL_D24/AD24		AB17
LCL_D25/AD25		AE18
LCL_D26/AD26		AD18
LCL_D27/AD27		AC18
LCL_D28/AD28		AE19
LCL_D29/AD29		AF20
LCL_D30/AD30		AD19
LCL_D31/AD31		AB18
LCL_DP0/C0/$\overline{\text{BE0}}$		AE12
LCL_DP1/C1/$\overline{\text{BE1}}$		AA13
LCL_DP2/C2/$\overline{\text{BE2}}$		AC15
LCL_DP3/C3/$\overline{\text{BE3}}$		AF19
$\overline{\text{IRQ0}}$/$\overline{\text{NMI\_OUT}}$		A11
$\overline{\text{IRQ7}}$/$\overline{\text{INT\_OUT}}$/$\overline{\text{APE}}$		E5
$\overline{\text{TRST}}$[1]		F22
TCK		A24
TMS		C24
TDI		A25
TDO		B24
$\overline{\text{TRIS}}$		C19

Table 25. MPC8275 and MPC8270 (VR and ZQ Packages) Pinout List (continued)

Pin Name		Ball
MPC8275/MPC8270	MPC8275 only	
PORESET[2]		B25
HRESET		D24
SRESET		E23
QREQ		D18
RSTCONF		E24
MODCK1/AP1/TC0/BNKSEL0		B16
MODCK2/AP2/TC1/BNKSEL1		F16
MODCK3/AP3/TC2/BNKSEL2		A15
CLKIN1		G22
PA0/RESTART1/DREQ3	FCC2_UTM_TXADDR2	AC20[2]
PA1/REJECT1/DONE3	FCC2_UTM_TXADDR1	AC21[2]
PA2/CLK20/DACK3	FCC2_UTM_TXADDR0	AF25[2]
PA3/CLK19/DACK4/L1RXD1A2	FCC2_UTM_RXADDR0	AE24[2]
PA4/REJECT2/DONE4	FCC2_UTM_RXADDR1	AA21[2]
PA5/RESTART2/DREQ4	FCC2_UTM_RXADDR2	AD25[2]
PA6	FCC2_UT_RXADDR3	AC24[2]
PA7/SMSYN2	FCC2_UT_TXADDR3	AA22[2]
PA8/SMRXD2	FCC2_UT_TXADDR4	AA23[2]
PA9/SMTXD2		Y26[2]
PA10/MSNUM5	FCC1_UT8_RXD0/FCC1_UT16_RXD8	W22[2]
PA11/MSNUM4	FCC1_UT8_RXD1/FCC1_UT16_RXD9	W23[2]
PA12/MSNUM3	FCC1_UT8_RXD2/ FCC1_UT16_RXD10	V26[2]
PA13/MSNUM2	FCC1_UT8_RXD3/ FCC1_UT16_RXD11	V25[2]
PA14/FCC1_MII_HDLC_RXD3	FCC1_UT8_RXD4/ FCC1_UT16_RXD12	T22[2]
PA15/FCC1_MII_HDLC_RXD2	/FCC1_UT8_RXD5/ FCC1_UT16_RXD13	T25[2]
PA16/FCC1_MII_HDLC_RXD1/ FCC1_RMII_RXD1	FCC1_UT8_RXD6/ FCC1_UT16_RXD14	R24[2]
PA17/FCC_MII_HDLC_RXD0/ FCC1_MII_TRAN_RXD/ FCCI_RMII_RXD0	FCC1_UT8_RXD7/ FCC1_UT16_RXD15	P22[2]
PA18/FCC1_MII_HDLC_TXD0/ FCC1_MII_TRAN_TXD/ FCC1_RMII_TXD0	FCC1_UT8_TXD7/FCC1_UT16_TXD15	N26[2]

This figure provides the mechanical dimensions and bottom surface nomenclature of the 516 PBGA (VR/ZQ) packages.

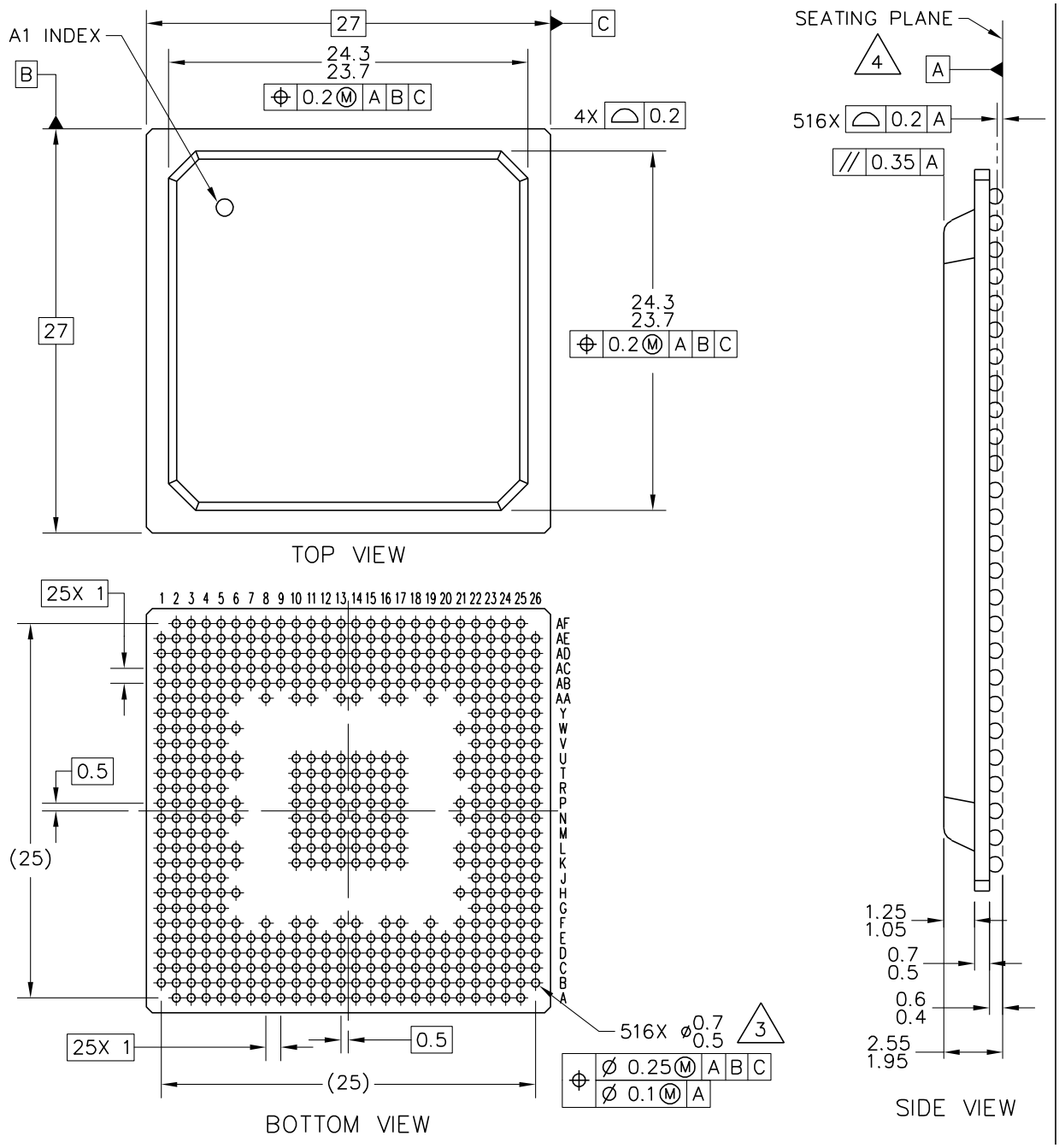

Figure 18. Mechanical Dimensions and Bottom Surface Nomenclature—516 PBGA